

KSA642

Low Frequency Power Amplifier

- Complement to KSD227
- Collector Power Dissipation: P_C = 400mW
 Suffix "-C" means Center Collector (1. Emitter 2. Collector 3. Base)



1. Emitter 2. Base 3. Collector

PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_a =25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{CBO}	Collector-Base Voltage	-30	V
V _{CEO}	Collector-Emitter Voltage	-25	V
V _{EBO}	Emitter-Base Voltage	-5	V
I _C	Collector Current (DC)	-300	mA
I _{CP}	* Collector Current (Pulse)	-500	mA
P _C	Collector Power Dissipation	400	mW
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 ~ 150	°C

^{*} PW≤10ms, Duty cycle≤50%

Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I_{C} = -100 μ A, I_{E} =0	-30			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = -10mA. I _B =0	-25			V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu A. I_C = 0$	- 5			V
I _{CBO}	Collector Cut-off Current	V _{CB} = -25V, I _E =0			-100	nA
I _{EBO}	Emitter Cut-off Current	V_{EB} = -3V, I_{C} =0			-100	nA
h _{FE}	* DC Current Gain	V_{CE} = -1V, I_{C} = -50mA	70		400	
V _{CE} (sat)	* Collector-Emitter Saturation Voltage	I _C = -300mA, I _B = -30mA		-0.35	-0.6	V

^{*} Pulse Test: PW≤350μs, Duty cycle≤2%

h_{FE} Classification

Classification	0	Υ	G
h _{FE}	70 ~ 140	120 ~ 240	200 ~ 400

Typical Characteristics

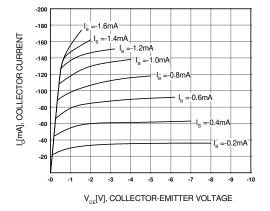


Figure 1. Static Characteristic

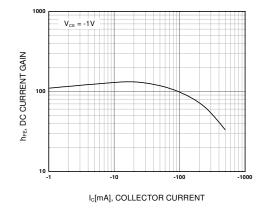


Figure 2. DC current Gain

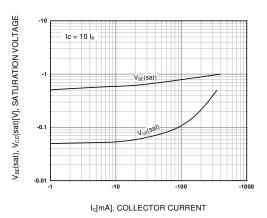


Figure 3. Base-Emitter Saturation Voltag Collector-Emitter Saturation Voltage

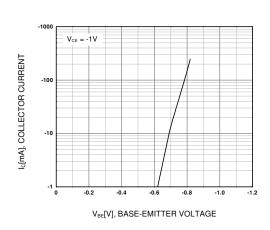


Figure 4. Base-Emitter On Voltage

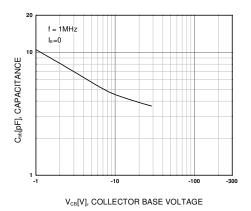
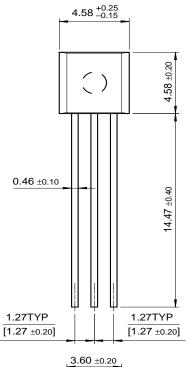


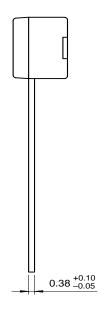
Figure 5. Collector Output Capacitance

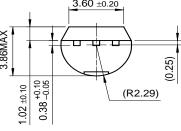
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Package Demensions

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